

# NUCLEO 144 H7 LEGACY

MB1364

H723ZG

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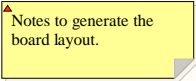


## Legend

General comment such as function title, configuration, ...

Text to be added to silkscreen.

Warning text.



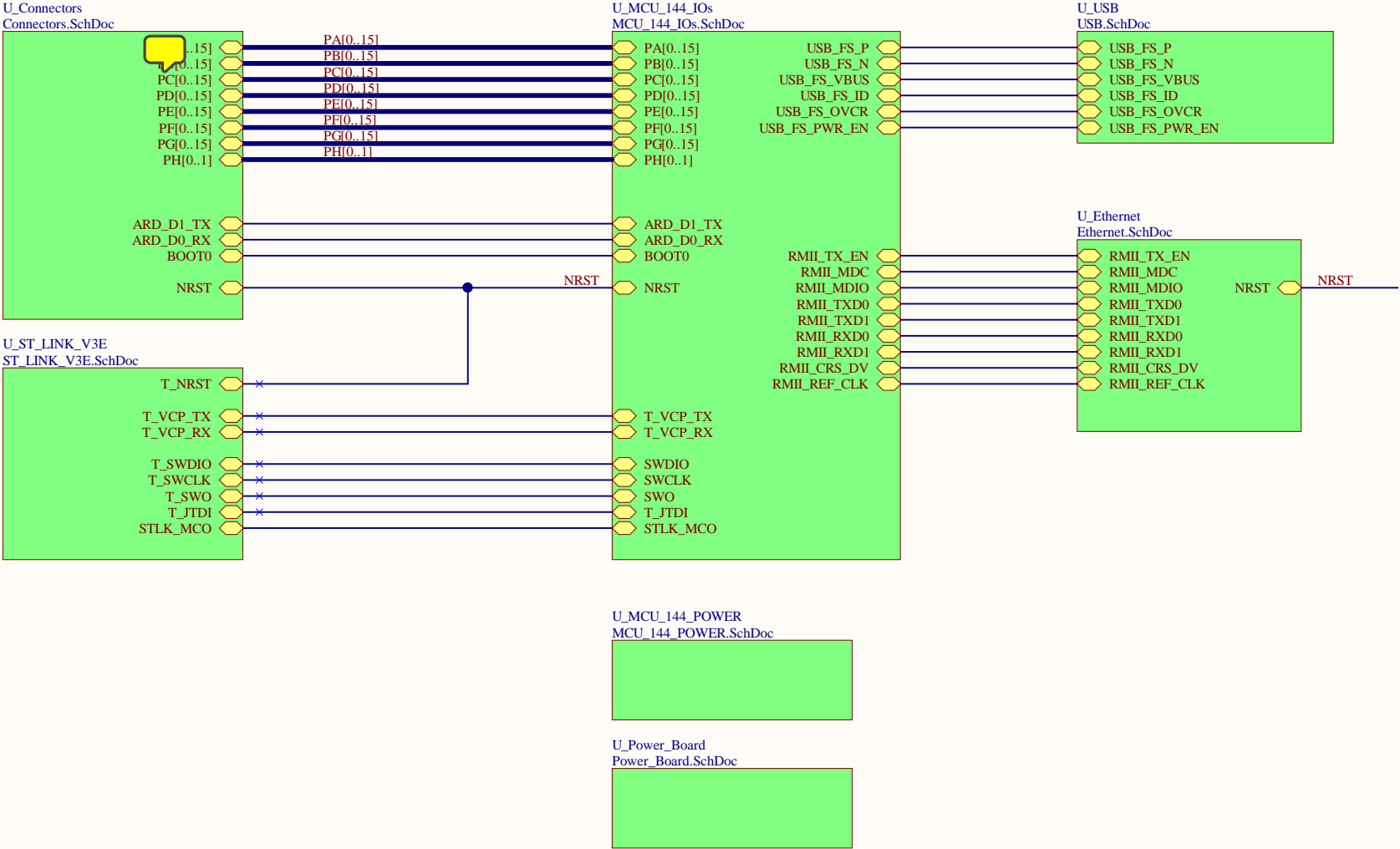
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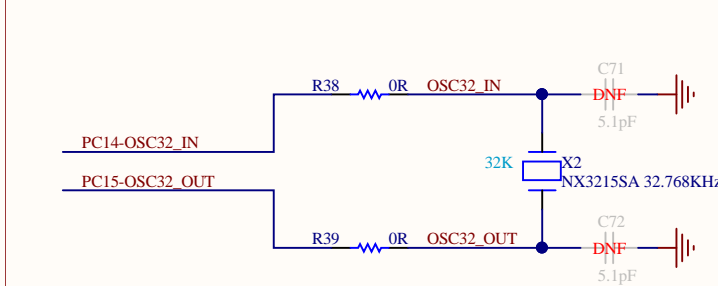
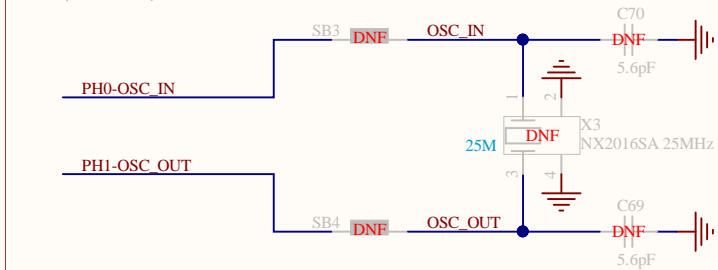
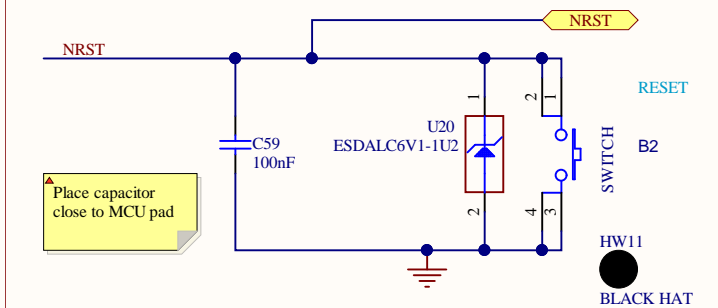
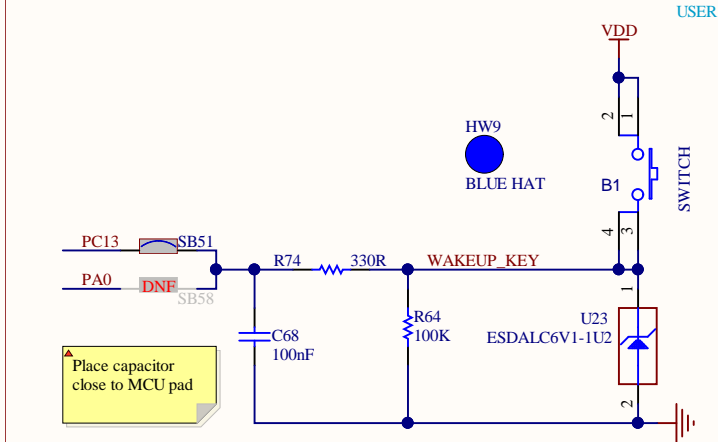
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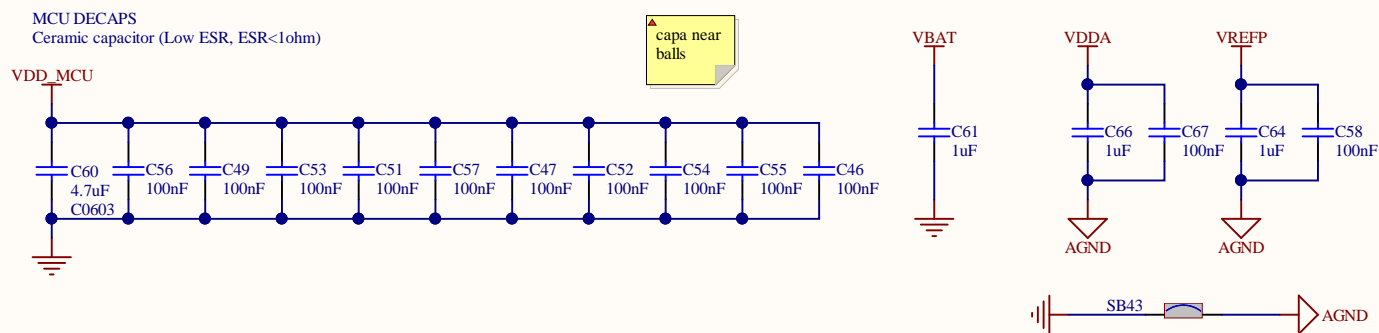
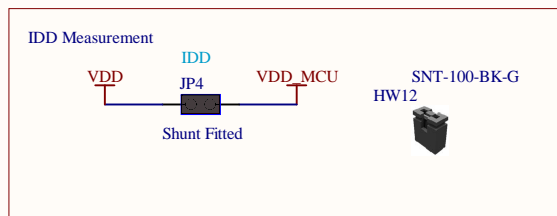
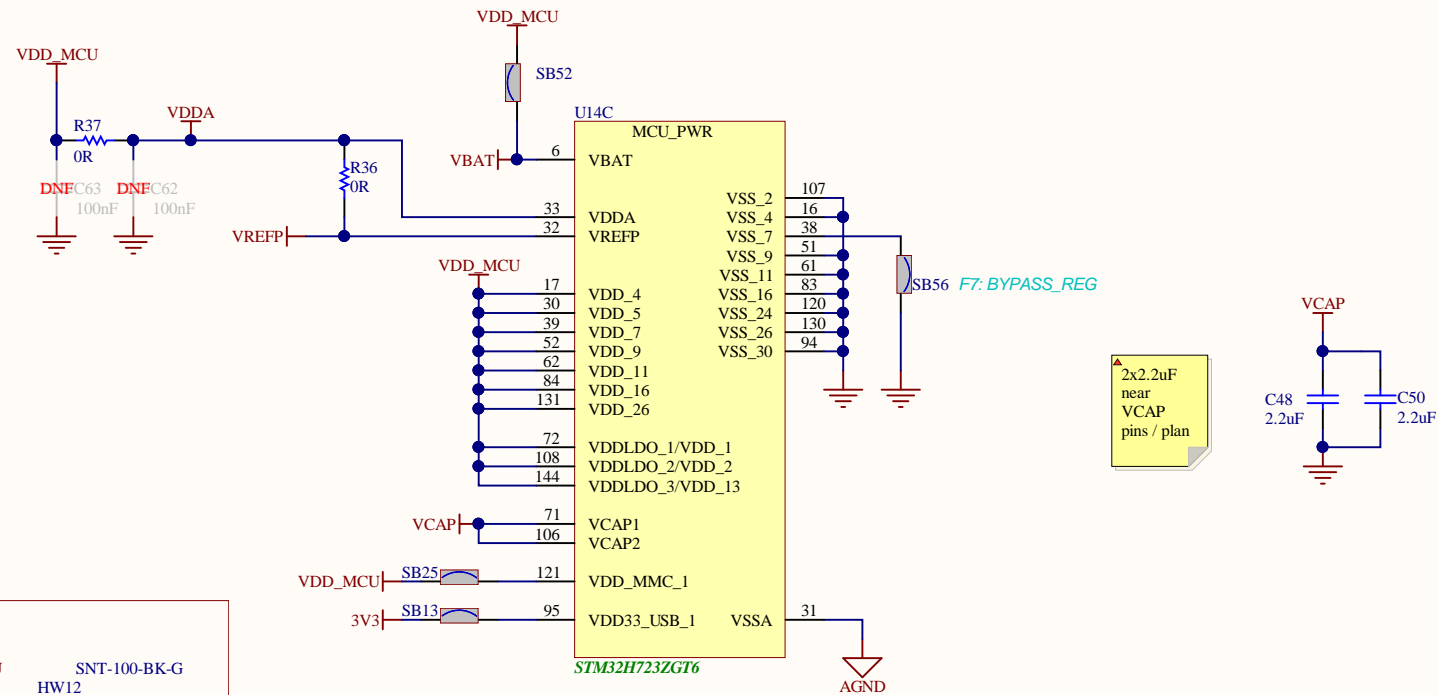
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Title: <b>MCU 144 POWER</b>		
Project: <b>NUCLEO 144 H7 LEGACY</b>		
Variant: <b>H723ZG</b>		
Revision: <b>E-01</b>		Reference: <b>MB1364</b>
Size: <b>A4</b>	Date: <b>16-OCT-2019</b>	Sheet: <b>4</b> of <b>9</b>





